

ANTREX Electronics

Electronic Components Sourcing Information

Product Reference Information

Part Number: BC56PA-QX
Manufacturer: Nexperia USA Inc.
Package: 3-PowerUDFN
Availability: Please confirm with sales

Product Page:

<https://antrexco.com/product/details/nexperia-usa-inc/bc56pa-qx.html>

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Note:

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



BC56PA-Q series

80 V, 1 A NPN medium power transistors

Rev. 2 — 24 June 2022

Product data sheet

1. General description

NPN medium power transistor in a SOT1061 (DFN2020-3) leadless very small Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- High collector current capability I_C and I_{CM}
- Three current gain selections
- High power dissipation capability
- Exposed heatsink for excellent thermal and electrical conductivity
- Leadless very small SMD plastic package with medium power capability
- Qualified according to AEC-Q101 and recommended for use in automotive applications

3. Applications

- Linear voltage regulators
- MOSFET drivers
- Low-side switches
- Power management
- Amplifiers
- Battery-driven devices

4. Quick reference data

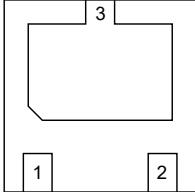
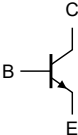
Table 1. Quick reference data
T_{amb} = 25 °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V _{CEO}	collector-emitter voltage	open base		-	-	80	V
I _C	collector current			-	-	1	A
I _{CM}	peak collector current	single pulse; t _p ≤ 1 ms		-	-	2	A
h _{FE}	DC current gain						
	BC56PA-Q	V _{CE} = 2 V; I _C = 150 mA	[1]	63	-	250	
	BC56-10PA-Q		[1]	63	-	160	
	BC56-16PA-Q		[1]	100	-	250	

[1] pulsed; t_p ≤ 300 μs; δ ≤ 0.02

5. Pinning information

Table 2. Pinning

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	B	base	 Transparent top view	 sym021
2	E	emitter		
3	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BC56PA-Q	DFN2020-3	plastic, thermal enhanced ultra thin small outline package; no leads; 3 Terminals; body 2 x 2 x 0.65 mm	SOT1061
BC56-10PA-Q			
BC56-16PA-Q			

7. Marking

Table 4. Marking

Type number	Marking code
BC56PA-Q	AZ
BC56-10PA-Q	BK
BC56-16PA-Q	BL

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CBO}	collector-base voltage	open emitter	-	100	V
V_{CEO}	collector-emitter voltage	open base	-	80	V
V_{EBO}	emitter-base voltage	open collector	-	5	V
I_C	collector current		-	1	A
I_{CM}	peak collector current	single pulse; $t_p \leq 1\text{ ms}$	-	2	A
I_B	base current		-	0.3	A
I_{BM}	peak base current	single pulse; $t_p \leq 1\text{ ms}$	-	0.3	A
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$ [1]	-	0.42	W
		[2]	-	0.83	W
		[3]	-	1.10	W
		[4]	-	0.81	W
		[5]	-	1.65	W
T_j	junction temperature		-	150	°C
T_{amb}	ambient temperature		-55	150	°C
T_{stg}	storage temperature		-65	150	°C

- [1] Device mounted on an FR4 Printed-Circuit-Board (PCB); single-sided copper; tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm^2 .
- [3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm^2 .
- [4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
- [5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm^2 .

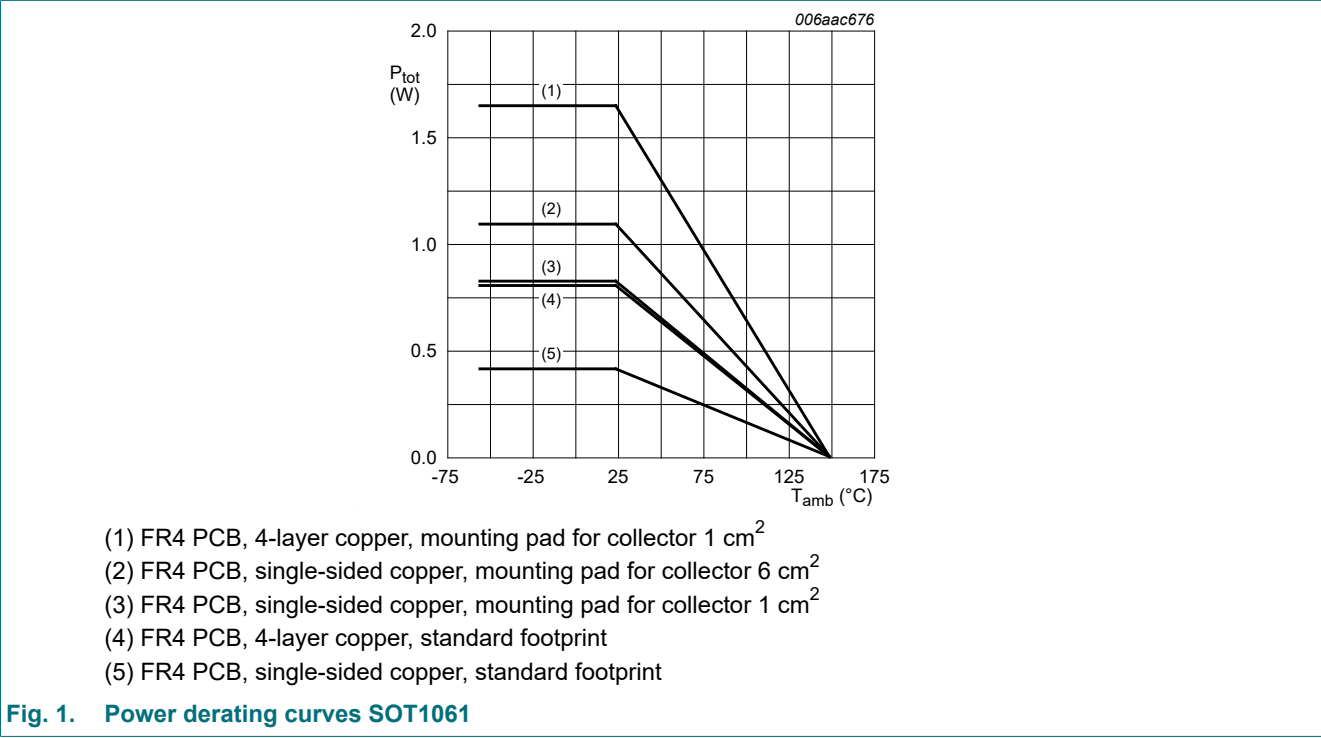


Fig. 1. Power derating curves SOT1061

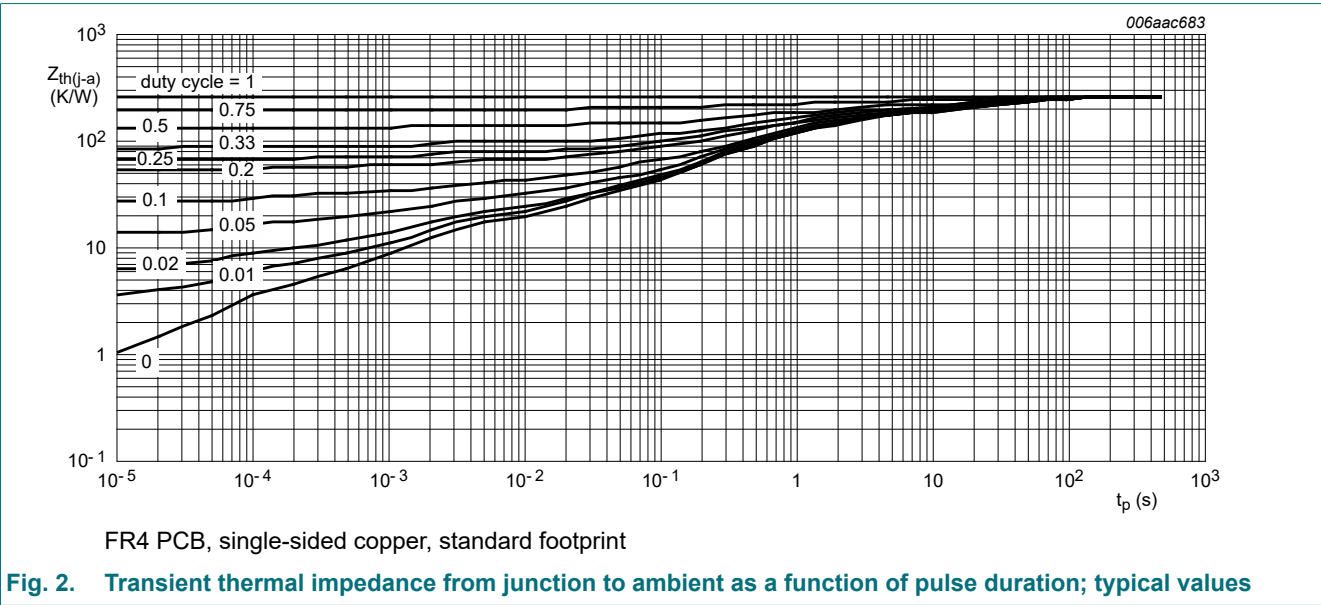
9. Thermal characteristics

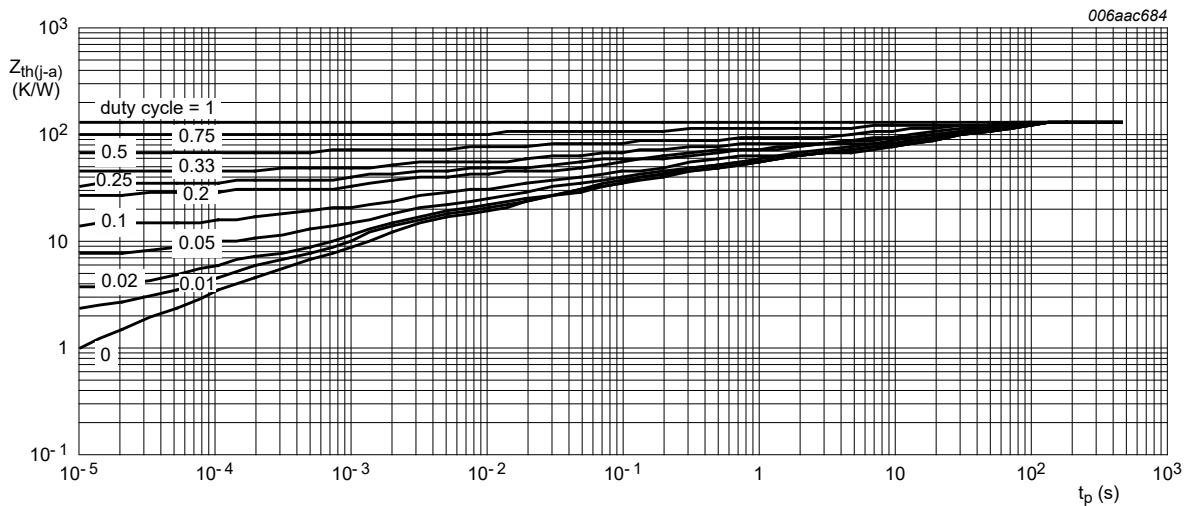
Table 6. Thermal characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	298	K/W
			[2]	-	-	151	K/W
			[3]	-	-	114	K/W
			[4]	-	-	154	K/W
			[5]	-	-	76	K/W
$R_{(j-sp)}$	thermal resistance from junction to solder point			-	-	20	K/W

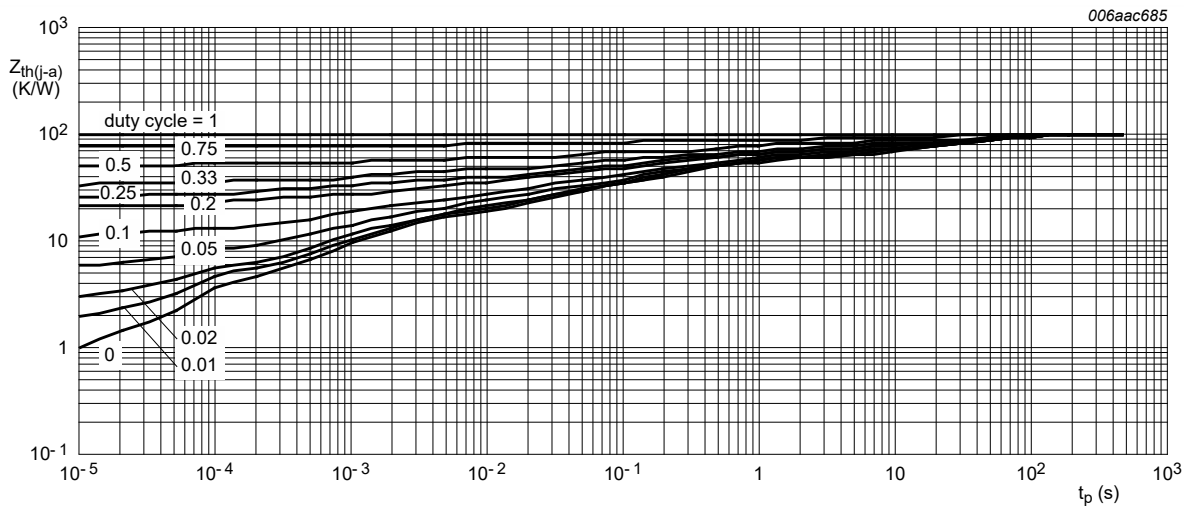
- [1] Device mounted on an FR4 PCB; single-sided copper; tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 1 cm².
[3] Device mounted on an FR4 PCB; single-sided copper; tin-plated; mounting pad for collector 6 cm².
[4] Device mounted on an FR4 PCB; 4-layer copper; tin-plated and standard footprint.
[5] Device mounted on an FR4 PCB; 4-layer copper; tin-plated; mounting pad for collector 1 cm².





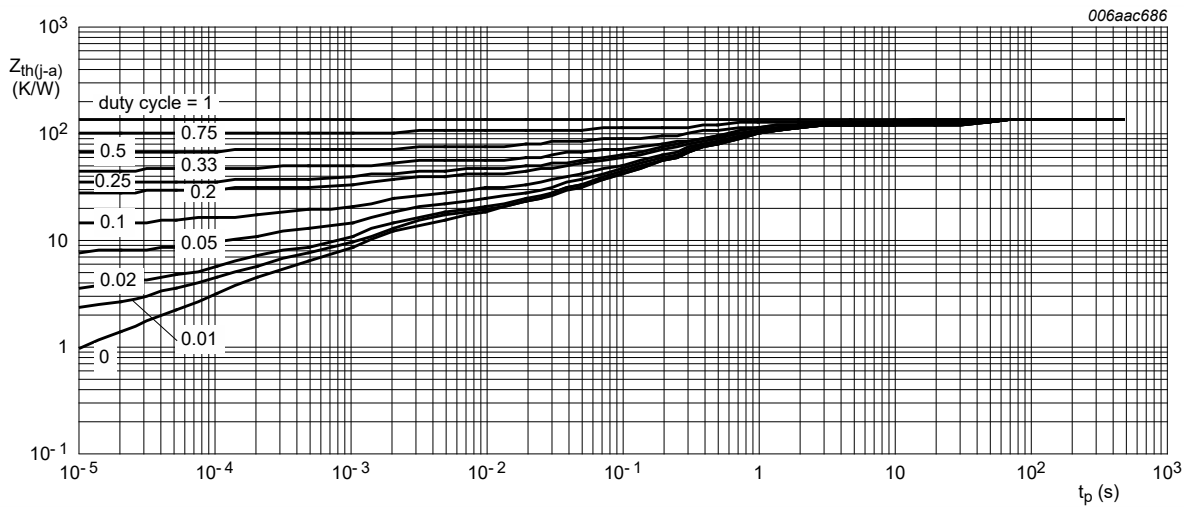
FR4 PCB, single-sided copper, mounting pad for collector 1 cm²

Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



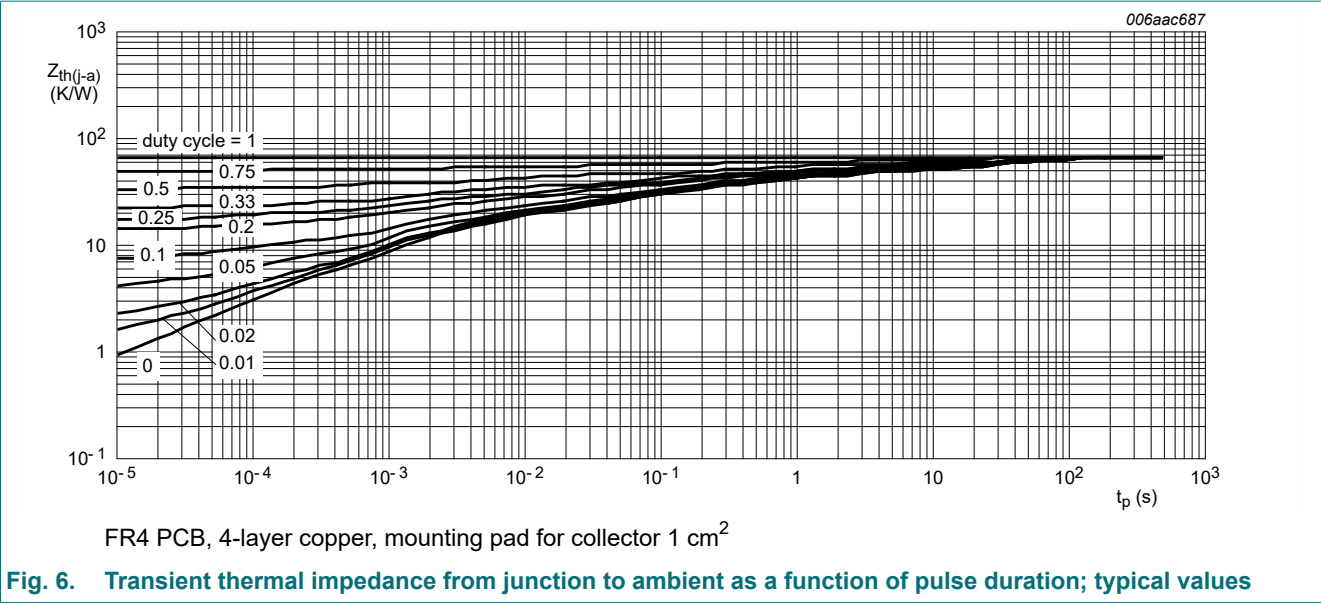
FR4 PCB, single-sided copper, mounting pad for collector 6 cm²

Fig. 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, 4-layer copper, standard footprint

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



10. Characteristics

Table 7. Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = 100\text{ }\mu\text{A}$; $I_E = 0\text{ A}$		100	-	-	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = 2\text{ mA}$; $I_B = 0\text{ A}$		80	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = 100\text{ }\mu\text{A}$; $I_C = 0\text{ A}$		5	-	-	V
I_{CBO}	collector-base cut-off current	$V_{CB} = 30\text{ V}$; $I_E = 0\text{ A}$		-	-	100	nA
		$V_{CB} = 30\text{ V}$; $I_E = 0\text{ A}$; $T_J = 150\text{ }^{\circ}\text{C}$		-	-	10	μA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5\text{ V}$; $I_C = 0\text{ A}$		-	-	100	nA
h_{FE}	DC current gain						
	BC56PA-Q	$V_{CE} = 2\text{ V}$; $I_C = 5\text{ mA}$	[1]	63	-	-	
		$V_{CE} = 2\text{ V}$; $I_C = 150\text{ mA}$	[1]	63	-	250	
		$V_{CE} = 2\text{ V}$; $I_C = 500\text{ mA}$	[1]	40	-	-	
	BC56-10PA-Q	$V_{CE} = 2\text{ V}$; $I_C = 5\text{ mA}$	[1]	63	-	-	
		$V_{CE} = 2\text{ V}$; $I_C = 150\text{ mA}$	[1]	63	-	160	
		$V_{CE} = 2\text{ V}$; $I_C = 500\text{ mA}$	[1]	40	-	-	
	BC56-16PA-Q	$V_{CE} = 2\text{ V}$; $I_C = 5\text{ mA}$	[1]	63	-	-	
		$V_{CE} = 2\text{ V}$; $I_C = 150\text{ mA}$		100	-	250	
		$V_{CE} = 2\text{ V}$; $I_C = 500\text{ mA}$		40	-	-	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 500\text{ mA}$; $I_B = 50\text{ mA}$	[1]	-	-	500	mV
V_{BE}	base-emitter voltage	$V_{CE} = 2\text{ V}$; $I_C = 500\text{ mA}$	[1]	-	-	1	V
C_C	collector capacitance	$V_{CB} = 10\text{ V}$; $I_E = i_e = 0\text{ A}$; $f = 1\text{ MHz}$		-	6	-	pF
f_T	transition frequency	$V_{CE} = 5\text{ V}$; $I_C = 50\text{ mA}$; $f = 100\text{ MHz}$		100	180	-	MHz

[1] pulsed; $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$

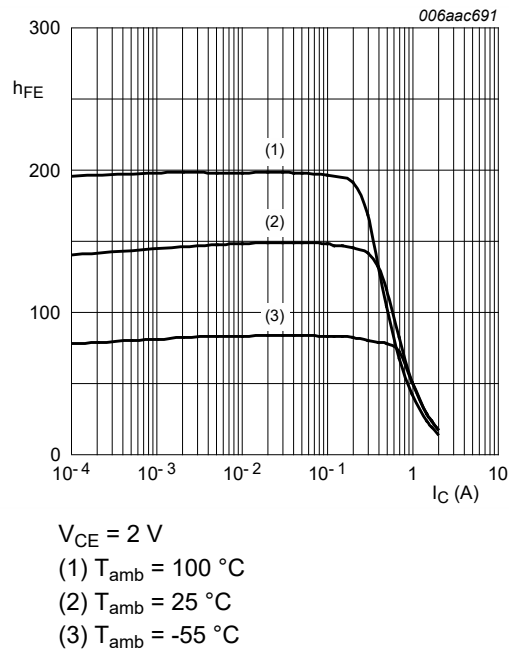


Fig. 7. DC current gain as a function of collector current; typical values

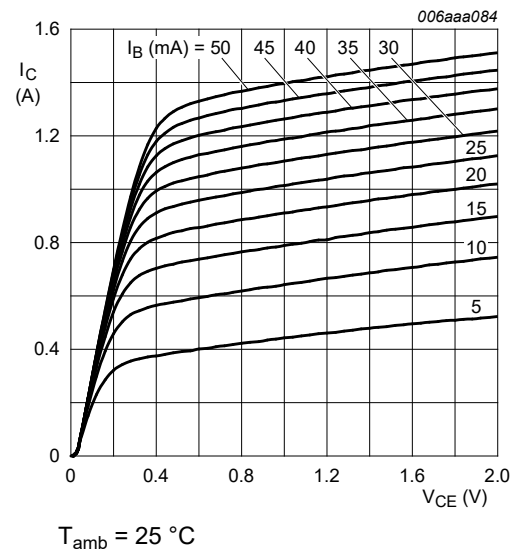


Fig. 8. Collector current as a function of collector-emitter voltage; typical values

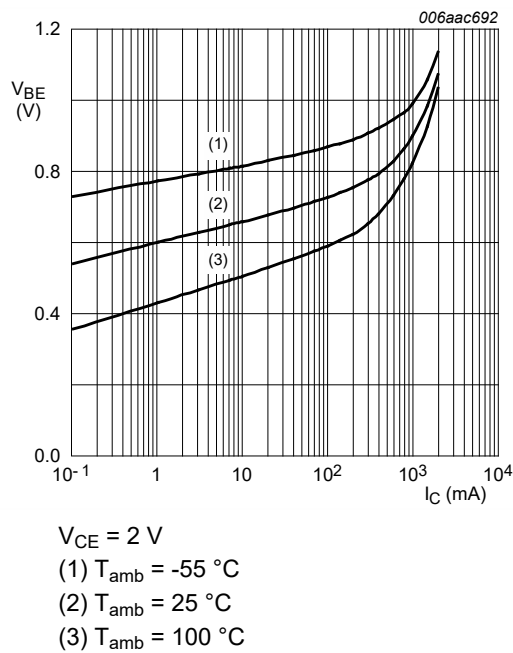


Fig. 9. Base-emitter voltage as a function of collector current; typical values

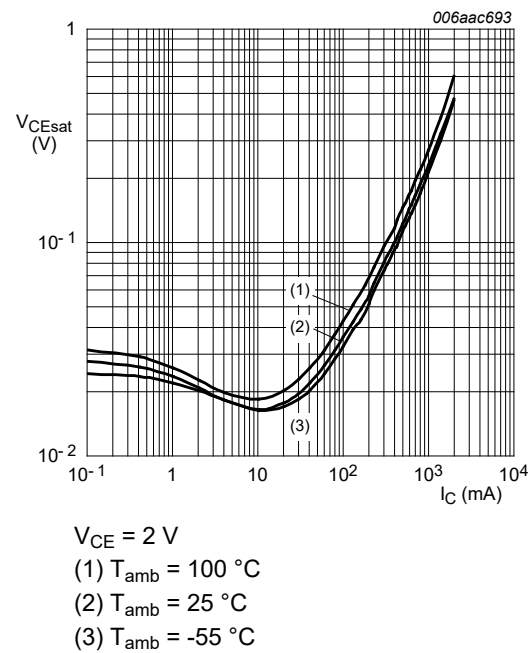


Fig. 10. Collector-emitter saturation voltage as a function of collector current; typical values

11. Test information

11.1. Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

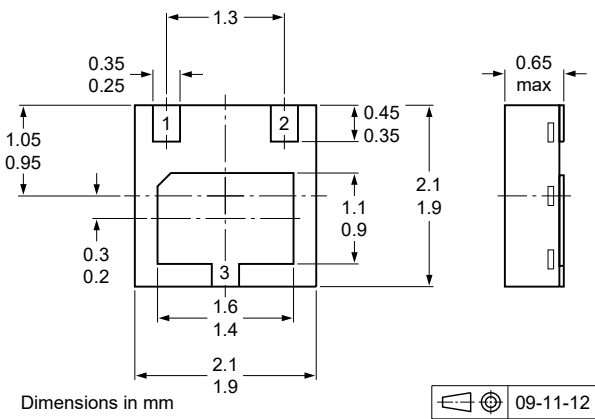


Fig. 11. Package outline SOT1061 (DFN2020-3)

13. Soldering

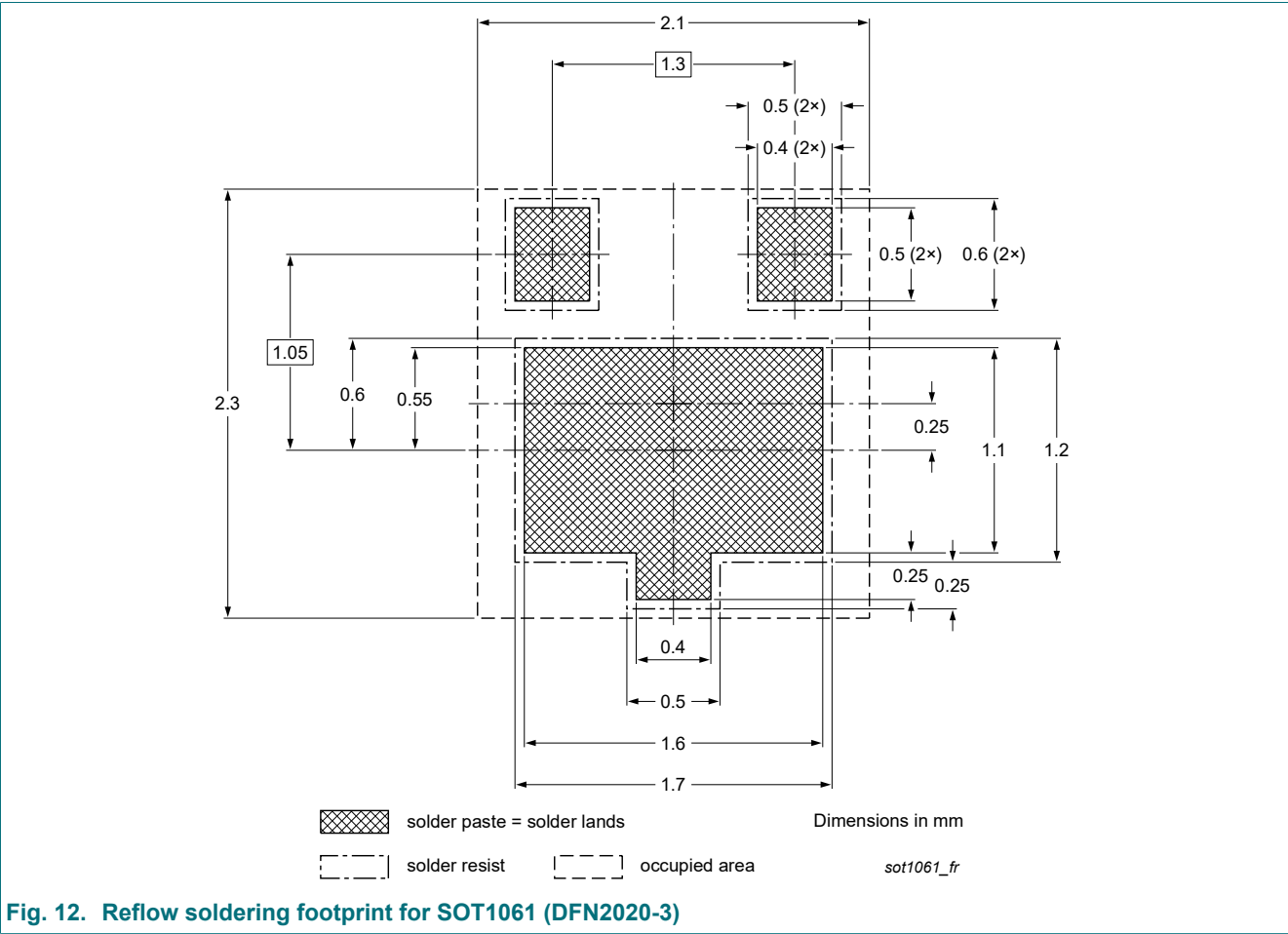


Fig. 12. Reflow soldering footprint for SOT1061 (DFN2020-3)

14. Revision history

Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BC56PA-Q_SER v.2	20220624	Product data sheet	-	BC56PA-Q_SER v.1
Modifications:	• Characteristics at $V_{(BR)CEO}$: Conditions corrected			
BC56PA-Q_SER v.1	20220119	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the internet at <https://www.nexperia.com>.

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